Electronic Patent Application Fee Transmittal								
Application Number:	10557694							
Filing Date:	22-Nov-2005							
Title of Invention:	RESIN FOR PHOTORESIST COMPOSITION, PHOTORESIST COMPOSITION AND METHOD FOR FORMING RESIST PATTERN							
First Named Inventor/Applicant Name:	Hideo Hada							
Filer:	Neil S. Bartfeld/Jennifer Dolan							
Attorney Docket Number:	SHIGA7.033APC							
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Basic Filing:								
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Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
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Utility Appl issue fee		1501	1	1510	1510			
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Printed copy of patent - no color	8001	10	3	30
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